



**SYKG1042E/Q5**

## Features

Tr 0.30815 31.632 8T Qm4 0.22988 Tmf 0 w 5367J > | Tf 0 w 1004r( )]/GSTJ > | Tf 0 w 10 0 -0 10 361.844025 4Tf / 0

**SYNK Semiconductor Technologies Co., Ltd.**

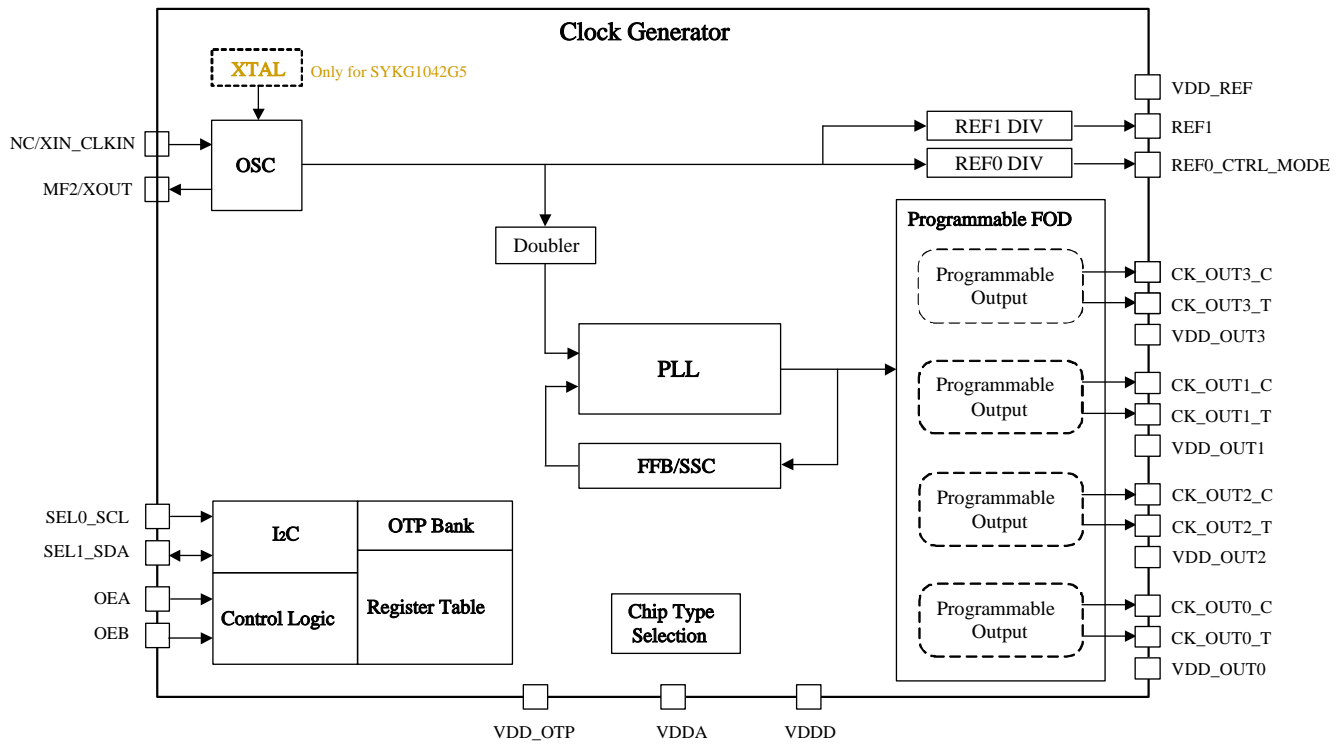
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**Tr 0.30815 31.632 203.524994 Tm .632988**

**Functional Block Diagram**

**Figure 1. SYKG1042E/Q5 Block Diagram**



**Notes:**

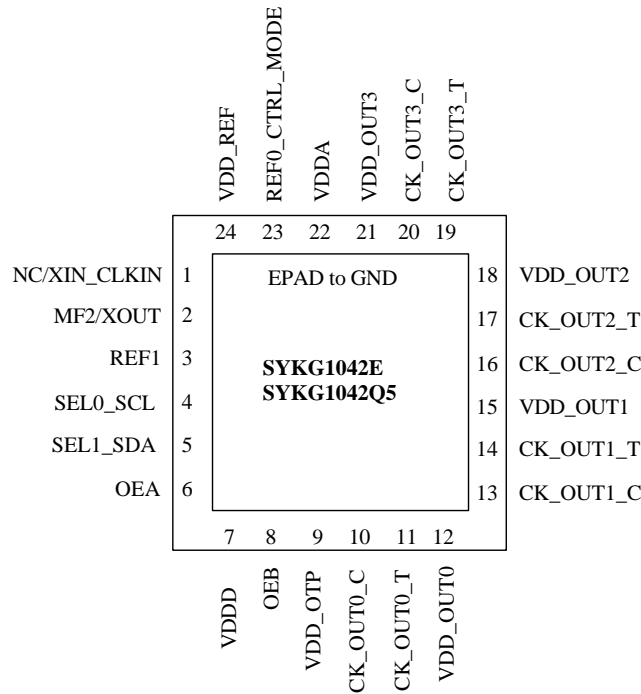
1. FFB: Fraction Feedback Divider  
 FOD: Fraction Output Divider  
 IN DIV: Input Divider  
 OTP: One-Time Programmable  
 PLL: Phase Locked Loop  
 SSC: Spread Spectrum Cloning  
 XTAL: Crystal



## 1 Pin Information

### 1.1 Pin Assignment

Figure 2. 24-VFQFPN / 24-LGA Pin Assignment, 4.0mm x 4.0mm, 0.5mm Pitch (Top view)



### 1.2 Pin Description

Table 1. Pin Description for SYKG1042E (24-VFPQFN) & SYKG1042Q5 (24-LGA) (Sheet 1 of 2)

PinNO.	PinName	Type	Description
1	NC/XIN_CLKIN	Input	Crystal input or reference clock input or multi-function pin.
2	MF2/XOUT	Input/Output	Crystal output or multi-function pin.
3	REF1	Output	LVCOS reference output.
4	SEL0_SCL	Input	Tri-state logic clock pin with 120k internal pull-up and pull-down. Be used as LSB of control mode selection or I2C SCL.
5	SEL1_SDA	Input/Output	Tri-state logic data pin with 120k internal pull-up and pull-down. Be used as MSB of control mode selection or I2C SDA.
6	OEA	Input	Active High input for enabling outputs. This pin has internal 120k pull-up resist or, and works with OEB.
7	VDDD	Power	Digital power. Connect to 1.8V, 2.5V, 3.3V.
8	OEB	Input	Active High input for enabling outputs. This pin has internal 120k pull-up resist or, and works with OEA.



**Table 1. Pin Description for SYKG1042E (24-VFPQFN) & SYKG1042Q5 (24-LGA) (Sheet 2 of 2)**

Pin NO.	Pin Name	Type	Description
9	VDD_OTP	Power	Voltage for OTP programming, 1.8V±10%. For Read operation, this pin can be connected to VDDD if VDDD is lower than 2.5V. This pin must be tied to ground or floating if the VDDD is greater than 2.5V. It is recommended to connect VDD_OTP to ground or leave VDD_OTP floating, no matter what level VDDD is.
10	CK_OUT0_C	Output	Complementary Output Clock0.
11	CK_OUT0_T	Output	Output Clock0.
12	VDD_OUT0	Power	Power supply for Output Clock0.
13	CK_OUT1_C	Output	Complementary Output Clock1.
14	CK_OUT1_T	Output	Output Clock1.
15	VDD_OUT1	Power	Power supply for Output Clock1.
16	CK_OUT2_C	Output	Complementary Output Clock2.
17	CK_OUT2_T	Output	Output Clock2.
18	VDD_OUT2	Power	Power supply for Output Clock2.
19	CK_OUT3_T	Output	Output Clock3.
20	CK_OUT3_C	Output	Complementary Output Clock3.
21	VDD_OUT3	Power	Power supply for Output Clock3.
22	VDDA	Power	Analog power. Connect to the same voltage as VDDD with suitable filtering.
23	REF0_CTRL_MODE	Strapping Pin	Chip configuration model selection and LVCMOS clock output. Tri-state logic input pin. At power-up, the state of this pin is latched to select the functionality of several hardware pins. After power-up, this pin acts as one LVCMOS reference output with the output frequency same as input reference or scale down to 1/64 at most.
24	VDD_REF	Power	Power supply for REF outputs and the internal XOUT. Nominal voltages are 1.8V, 2.5V and 3.3V.
25	EPAD	GND	Connect to ground.

**2 Mechanical Package Data**

**Figure 3. 24-VFQFPN Package Outline (4.0mm x 4.0mm x 0.75mm, 0.5mm Pitch)**

D		B		A	
↓					
DIMENSIONS = MILLIMETER)	NOM	MAX			
	0.75	0.80			
	0.02	0.05			
	03REF				
	0.25	0.30			
	4.00	4.10			
	4.00	4.10			
	2.50	2.60			
	2.50	2.60			
	0.50	0.60			
35REF					
	0.40	0.45			
	0.08				
	0.08				

ARD MO-220 WGGD-8.  
DIMENSIONS.

REV. 1/1  
SHEET 1/1



### 3 Ordering Information

Part Number	Package	Temperature	Crystal	Packing
SYKG1042E-XX	4mm x 4mm x 0.75mm, 0.5 pitch 24-VFQFPN; MSL Level-3-260C	-40 ~ +85°C	External	Tray
SYKG1042E-XX-T				Tape & Reel
SYKG1042Q5-XX	4mm x 4mm x 1.10mm, 0.5 pitch 24-LGA; MSL Level-3-260C	-40 ~ +85°C	50MHz Internal	Tray
SYKG1042Q5-XX-T				Tape & Reel

For more information on the product, please contact <https://www.yxc.hk>